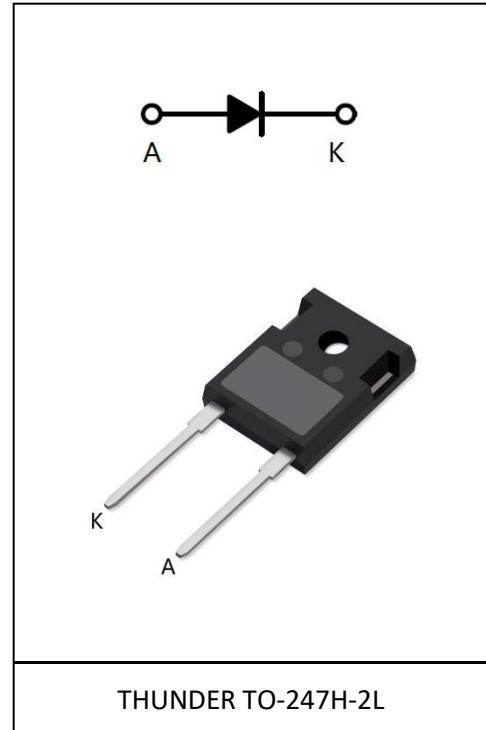


Thunder High Power Products

## Standard Rectifier

### Features:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour
- High commutation robustness
- High surge capability



### Description/Applications

### Product Summary

- Diode for main rectification
- For single and three phase bridge configurations
- Bypass diode

$V_{RRM}$	2000V
$I_{F(AV)}$	75A
$VF(@100A)$	1.25A

**Table1: Absolute Maximum Ratings**

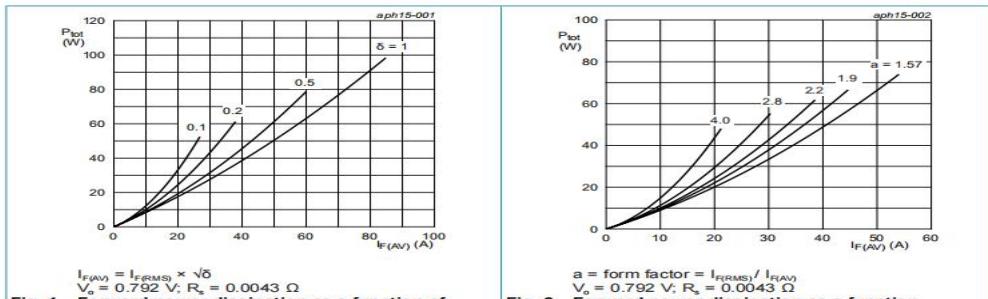
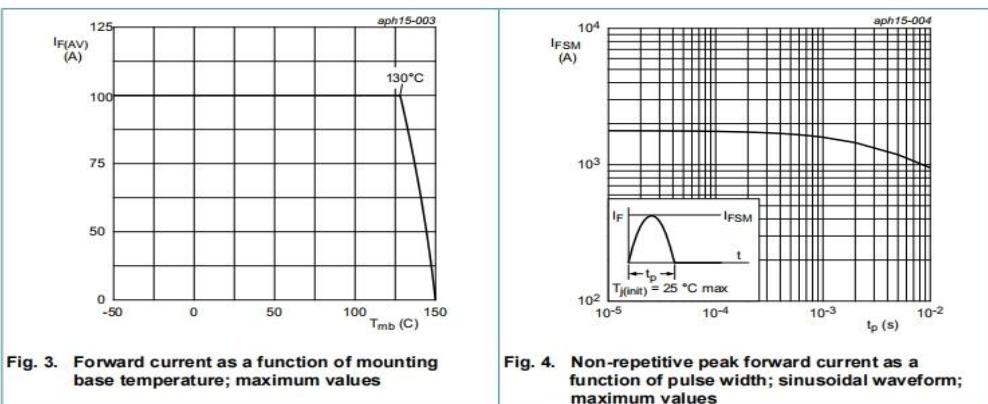
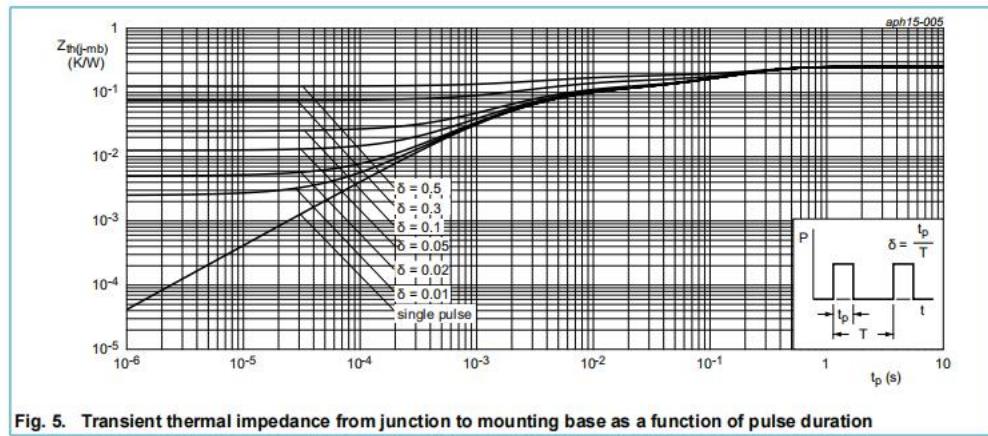
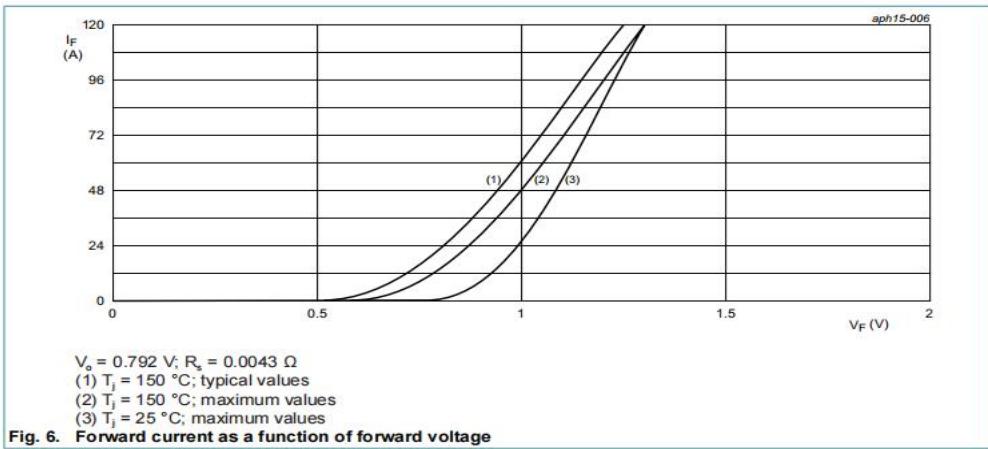
Parameter	Symbol	Test Conditions	Values	Units
Max non-Repetitive peak reverse voltage	$V_{RSM}$		2000	V
Max Repetitive peak reverse voltage	$V_{RRM}$		2000	V
Average forward current	$I_{F(AV)}$	$T_c = 150^\circ C$	100	A
Peak forward surge current ( 10ms single half sine-wave )	$I_{FSM}$	$T_c = 25^\circ C$	1000	
Operating junction temperature	$T_j$		150	°C
Storage temperatures	$T_{stg}$		-55 to +175	°C
Total power dissipation	$P_{tot}$		250	W

**Table2: Electrical characteristics (Tc=25°C unless otherwise specified)**

Parameter	Symbol	Test Conditions	Min	Typ.	Max.	Units
Breakdown voltage Blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> =100μA	2000			V
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =75A (25°C)			1.25	
		I <sub>F</sub> =100A (25°C)			1.35	
Reverse current	I <sub>R</sub>	V <sub>R</sub> =1800V			2	μA
		T <sub>j</sub> =150°C, V <sub>R</sub> =1800V			1500	

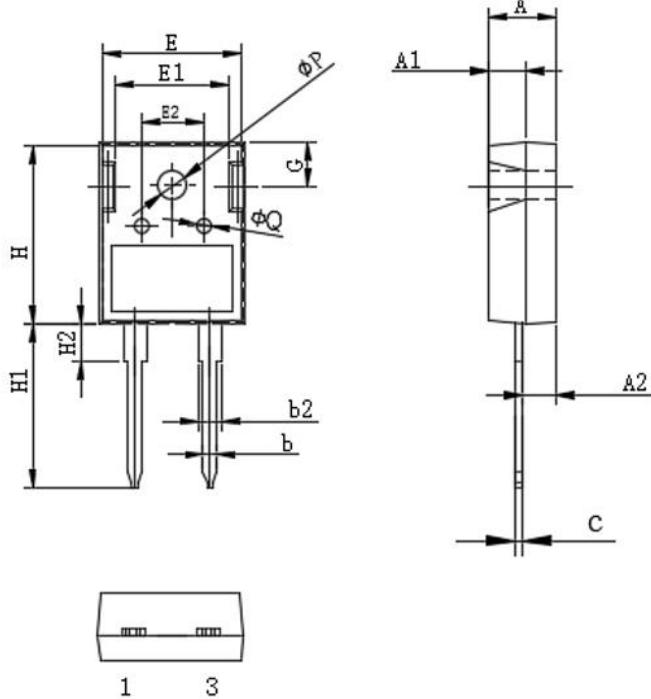
**Table3: Thermal characteristics**

Paramter	Symbol	Typ	Max	Units
Junction-to-Case	R <sub>θJC</sub>	0.25	0.5	°C/W

**Table4: Electrical performance (typical)**

**Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values**
**Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values**

**Fig. 3. Forward current as a function of mounting base temperature; maximum values**
**Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values**

**Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration**

**Fig. 6. Forward current as a function of forward voltage**

## Package Information

### TO-247H-2L PACKAGE



基本尺寸

Symbol	单位 mm		
	Min	Nom	Max
A	4.80	5.00	5.20
A1	2.80	3.00	3.20
A2	2.20	2.40	2.60
b	1.05	1.20	1.35
b2	1.80	2.00	2.20
c	0.50	0.60	0.70
E	15.6	15.80	16.0
E1	12.3	12.50	12.7
E2	6.00	6.20	6.40
H	20.5	21.0	21.5
H1	19.0	20.0	21.0
H2	3.00	4.00	5.00
G	5.70	5.90	6.10
ΦP	3.30	3.50	3.50
ΦQ	2.30	2.50	2.70

## Notice

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